

ABSOLUTE MAXIMUM RATINGS

Supply Voltage (Vcc).....-0.3V to + 6.0V
V+ (Note 1).....-0.3V to + 7.0V
V- (Note 1).....+0.3V to - 7.0V
|V+| + |V-|+13V
Input voltage at TTL input pins-0.3V to Vcc+0.3V
RxIN..... ±16V
Driver output (from Ground)..... ±13.2V
RxOUT, STATUS.....-0.3V to Vcc+0.3V
Short Circuit Duration, TxOUT to GND., Continuous
(One output at a time maximum)
Storage Temperature.....-65°C to +150°C
Operating Temperature SP322XECX.....0°C to +70°C
Operating Temperature SP322XEEX.....-40°C to +85°C
Lead Temperature (soldering, 10s)..... +300°C

Maximum junction temperature.....150°C

Thermal Derating, Junction to Ambient

SSOP20..... $\theta_{JA} = 83^{\circ}\text{C/W}$
TSSOP20..... $\theta_{JA} = 110.7^{\circ}\text{C/W}$
SSOP16..... $\theta_{JA} = 87^{\circ}\text{C/W}$
TSSOP16..... $\theta_{JA} = 100.4^{\circ}\text{C/W}$

Note 1: V+ and V- can have maximum magnitudes of 7V, but their absolute difference cannot exceed 13V.

These are stress ratings only and functional operation of the device at these ratings or any other above those indicated in the operation sections of the specifications below is not implied. Exposure to absolute maximum rating conditions for extended periods of time may affect reliability.

ELECTRICAL SPECIFICATIONS

Unless otherwise noted Vcc = +3.0V to +5.5V, Tamb = Tmin to Tmax,. Typical values are at Tamb = +25°C.
C1–C4 = 0.1µF tested at 3.3V ±10%. C1=0.047µF C2–C4 = 0.33µF tested at 5V ±10%.

Parameters		Symb	Test Conditions	Min.	Typ.	Max.	Unit
DC Characteristics							
Supply Current, Auto On-Line® Plus		Icc3	Receivers idle, TxIN = Vcc or GND, ONLINE = GND, SHUTDOWN = Vcc Note 2		1	10	µA
Supply Current, Shutdown		Icc2	SHUTDOWN = GND		1	10	µA
Supply Current, Active		Icc1	ONLINE = SHUTDOWN = Vcc, No Load		1.5	3.0	mA
Supply Current, Active		Icc1	ONLINE = SHUTDOWN = Vcc=3.3V, No Load		0.7	2.0	mA
Driver Input and Logic Input Pins							
Logic Input Voltage	High	VIH	Vcc = 3.3V	2			V
		VIH	Vcc = 5.0V	2.4			
	Low	VIL				0.8	
	Logic Threshold	VT			1.5		
Logic Input Leakage Current		IL			0.05	±1.0	µA
Logic Input Hysteresis		VHYS			100		mV
Receiver Outputs and STATUS Output							
Receiver Output Voltage Low		VOL	IOUT = -1.6mA			0.4	V
Receiver Output Voltage High		VOH	IOUT = 1mA	Vcc - 0.6			V

Note 2: Characterized, not 100% tested.

ELECTRICAL SPECIFICATIONS

Unless otherwise noted $V_{CC} = +3.0V$ to $+5.5V$, $T_{AMB} = T_{MIN}$ to T_{MAX} . Typical values are at $T_{AMB} = +25^{\circ}C$.
 $C1-C4 = 0.1\mu F$ tested at $3.3V \pm 10\%$. $C1=0.047\mu F$ $C2-C4 = 0.33\mu F$ tested at $5V \pm 10\%$.

Parameters	Symb	Test Conditions	Min.	Typ.	Max.	
Driver Outputs						
Output Voltage Swing	V_o	Output load = $3k\Omega$ to GND	± 5.0	± 6.0		V
		Output load = Open Circuit			± 15.0	
Short Circuit Current		$V_{OUT} = 0V$			± 60	mA
Power-Off Impedance		$V_{CC}=V+ = V- = 0$ transmitter outputs= $\pm 2V$	300	10M		Ω
Output Leakage Current		$V_{CC} = 0$ or $3V$ to $3.3V$, $V_{OUT} = \pm 12V$, Drivers disabled			± 25	μA
Receiver Inputs						
Input Voltage Range			-15		15	V
Input Threshold Low		$V_{CC} = 3.3V$	0.6	1.2		V
		$V_{CC} = 5.0V$	0.8	1.5		
Input Threshold High		$V_{CC} = 3.3V$		1.5	2.4	V
		$V_{CC} = 5.0V$		1.8	2.4	
Input Hysteresis				500		mV
Input Resistance			3	5	7	$k\Omega$
ESD Protection						
ESD Protection for R_In, T_Out pins		Human Body Model		± 15		kV
All Other Pins		Human Body Model		± 2		kV
Auto On-line[®] Plus ($\overline{ONLINE} = GND$, $SHUTDOWN = V_{CC}$)						
Rx Input Threshold to $\overline{STATUS}$ output high					± 2.7	V
Rx Input Threshold to $\overline{STATUS}$ output low			± 0.3			V
Threshold to $\overline{STATUS}$ high	t_{STH}			0.5		μs
Threshold to $\overline{STATUS}$ low	t_{STL}			30		μs
Rx or Tx transition to drivers enabled	t_{ONLINE}	Note 3		100		μs
Last Rx or Tx transition to drivers disabled	$t_{OFFLINE}$	Note 2, 3	15	30	60	sec

Note 3: A transmitter/receiver edge is defined as a transition through input logic thresholds.

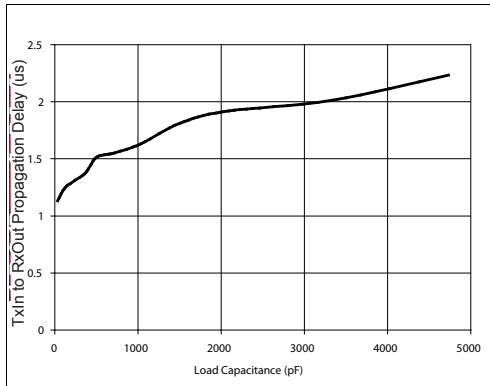
TIMING CHARACTERISTICS

Unless otherwise noted $V_{CC} = +3.0V$ to $+5.5V$, $T_{AMB} = T_{MIN}$ to T_{MAX} ,. Typical values are at $T_{AMB} = +25^{\circ}C$. C1–C4 = $0.1\mu F$ tested at $3.3V \pm 10\%$. C1= $0.047\mu F$ C2–C4 = $0.33\mu F$ tested at $5V \pm 10\%$

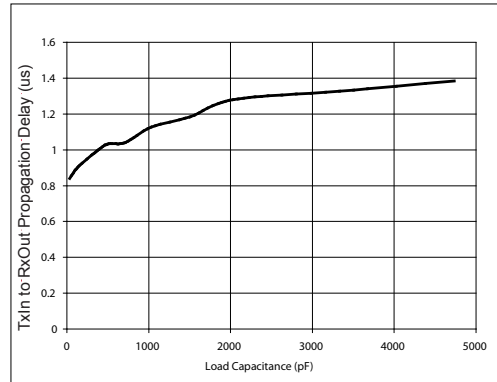
Parameters	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
SP3224E and SP3226E						
Maximum Data Rate		$R_L = 3k\Omega$, $C_L = 1000pF$. One transmitter switching.	250			kbps
Transition -Region Slew Rate		Measurement taken from $+3.0V$ to $-3.0V$ or $-3.0V$ to $+3.0V$, $T_{AMB} = 25^{\circ}C$ $R_L = 3k\Omega$ to $7k\Omega$, $C_L = 150pF$ to $1000pF$	4		30	$V/\mu s$
Receiver Propagation Delay	t_{RPHL} , t_{RPLH}	R_{IN} to R_{OUT} , $C_L = 150pF$		0.22		μs
Receiver Output Enable Time	t_{RZH} , t_{RZL}	$R_L = 3k\Omega$, $C_L = 150pF$		0.2	2	μs
Receiver Output Disable Time	t_{RHZ} , t_{RLZ}			0.2	2	μs
Receiver Skew		$ t_{PHL} - t_{PLH} $ at 1.5V		200		ns

Parameters	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
SP3225E and SP3227E						
Maximum Data Rate		$R_L = 3k\Omega$, $C_L = 250pF$. One transmitter Switching	1000			kbps
		$R_L = 3k\Omega$, $C_L = 1000pF$. One transmitter Switching	500			kbps
Instantaneous Slew Rate		Measurement taken from $+3.0V$ to $-3.0V$ or $-3.0V$ to $+3.0V$, $T_{AMB}=25^{\circ}C$ $R_L = 3k\Omega$ to $7k\Omega$, $C_L = 150pF$ to $250pF$	24		150	$V/\mu s$
Driver Skew	$ t_{DPHL} - t_{DPLH} $	at zero crossing		75		ns
Receiver Propagation Delay	t_{RPHL} , t_{RPLH}	R_{IN} to R_{OUT} , $C_L = 150pF$		0.20		μs
Receiver Output Enable Time	t_{RZH} , t_{RZL}			0.3	2	μs
Receiver Output Disable Time	t_{RHZ} , t_{RLZ}			0.2	2	μs
Receiver Skew	$ t_{PHL} - t_{PLH} $	at 1.5V		80		ns

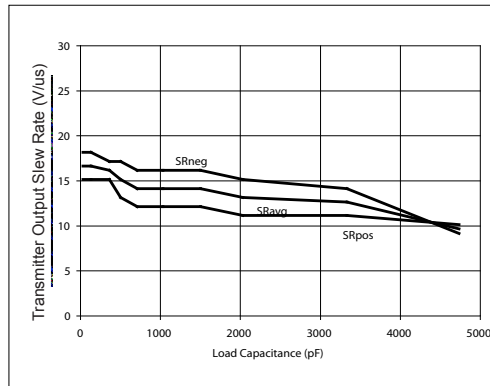
TYPICAL PERFORMANCE CHARACTERISTICS: CURVES



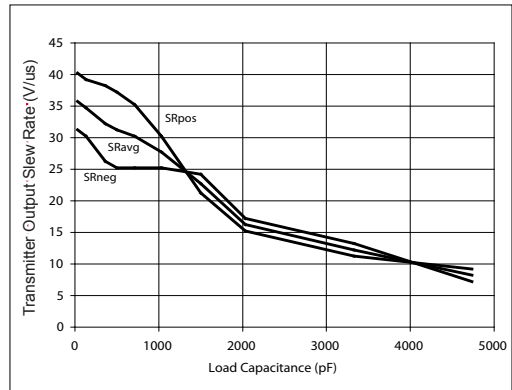
SP3224E/SP3226E Transmitter Input to Receiver Output Propagation Delay vs. Load Capacitance



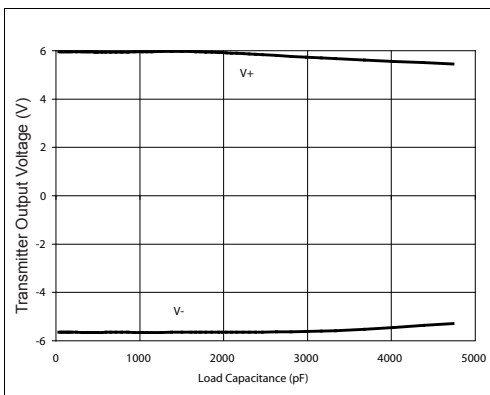
SP3225E/SP3227E Transmitter Input to Receiver Output Propagation Delay vs. Load Capacitance



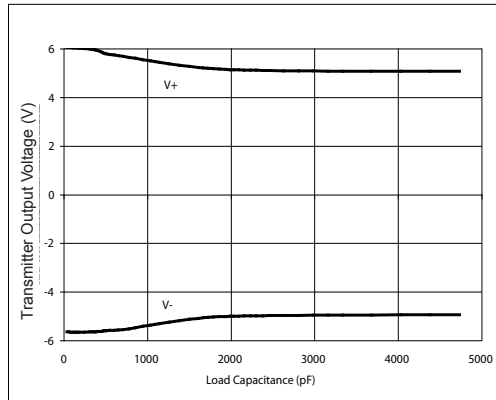
SP3224E/SP3226E Transmitter Output Slew Rate vs. Load Capacitance



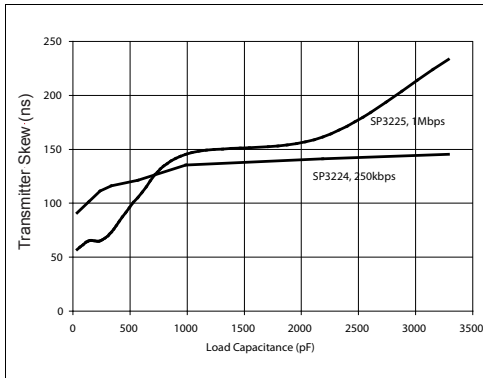
SP3225E/SP3227E Transmitter Output Slew Rate vs. Load Capacitance



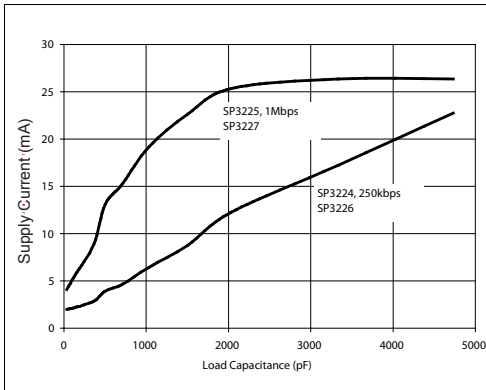
SP3224E/SP3226E Transmitter Output Voltage vs. Load Capacitance



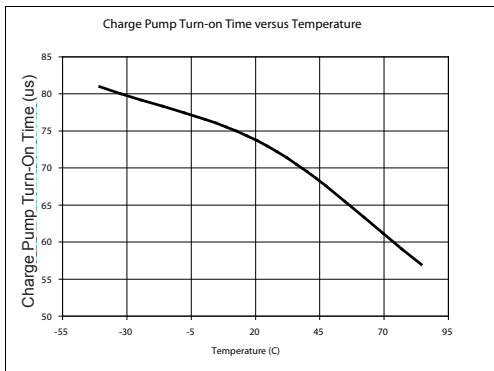
SP3225E/SP3227E Transmitter Output Voltage



Driver Skew
vs. Load Capacitance

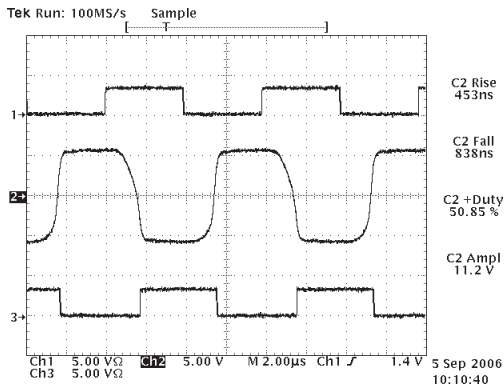


Supply Current
vs. Load Capacitance

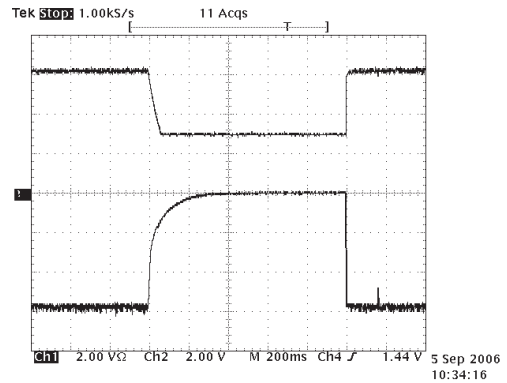


Charge Pump Turn-On Time
vs. Temperature

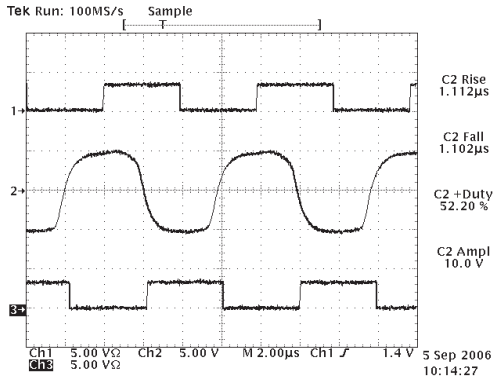
TYPICAL PERFORMANCE CHARACTERISTICS: SCOPE SHOTS



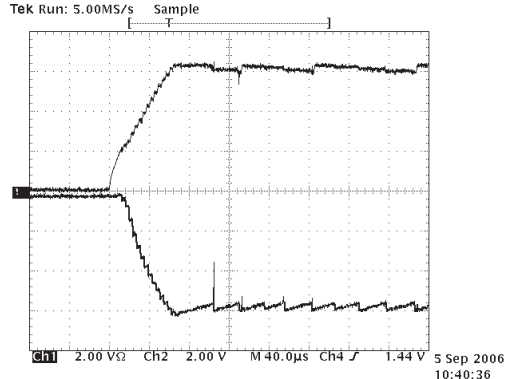
SP3224E/SP3226E Waveforms
for 250kbps Clock Rate, $R_L=3k\Omega$,
 $C_L=1000pF$



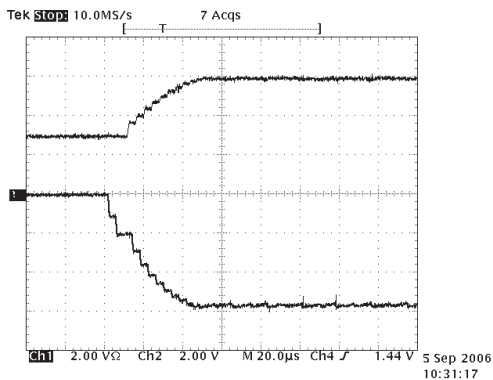
SP3224E/SP3226E Charge Pump
Into Shutdown



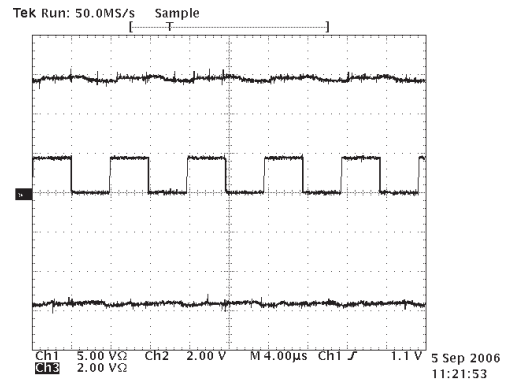
SP3224E/SP3226E Waveforms
for 250kbps Clock Rate, $R_L=3k\Omega$,
 $C_L=4700pF$



SP3224E/SP3226E Charge Pump
Power On Time, $V_{CC}=3.3V$



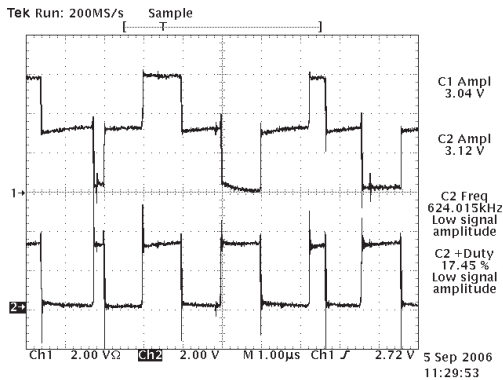
SP3224E/SP3226E Charge Pump
Out of Shutdown



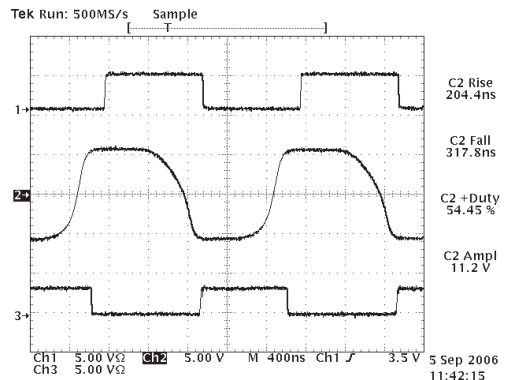
SP3224E/SP3226E Charge Pump
Waveforms for 250kbps Clock Rate

All Charge Pump waveforms use charge pump capacitor values $C1-C4 = 0.1\mu F$

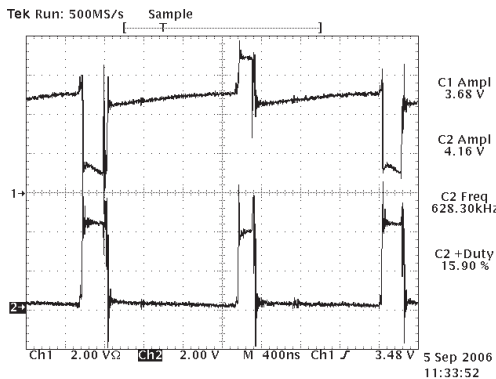
TYPICAL PERFORMANCE CHARACTERISTICS: SCOPE SHOTS



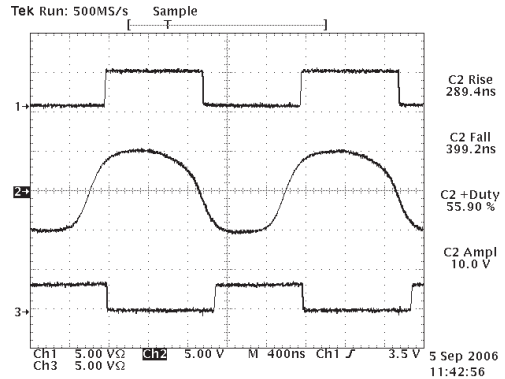
SP3224E/SP3226E C2+ Charge Pump Waveforms, Vcc=3.3V, All Channels switching



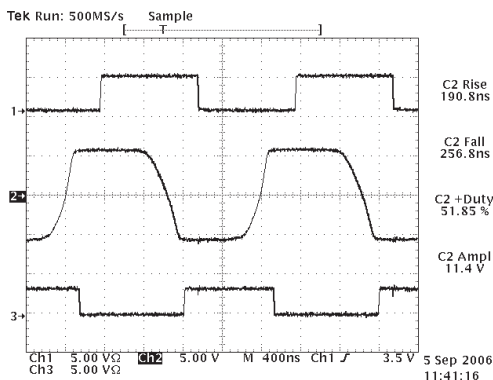
SP3225E/SP3227E Waveforms for 1Mbps Clock Rate, RL=3KΩ, CL=250pF



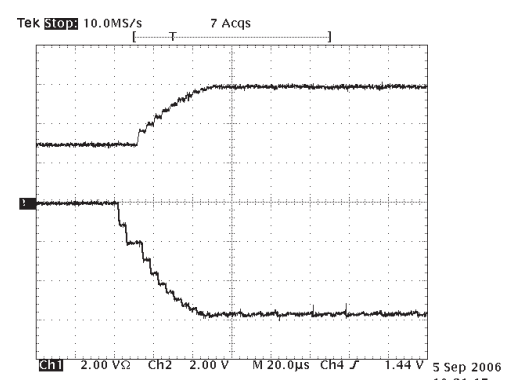
SP3224E/SP3226E C2+ Charge Pump Waveforms, Vcc=5V, All Channels switching



SP3225E/SP3227E Waveforms for 1Mbps Clock Rate, RL=3KΩ, CL=1000pF



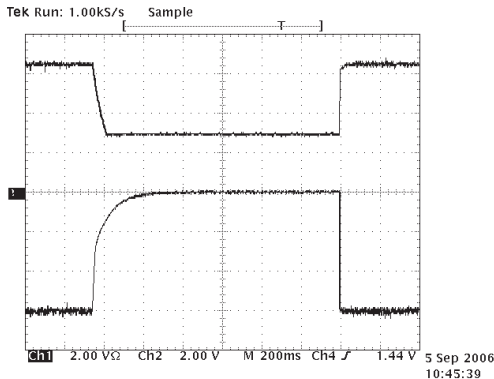
SP3225E/SP3227E Waveforms for 1Mbps Clock Rate, RL=3KΩ, CL=50pF



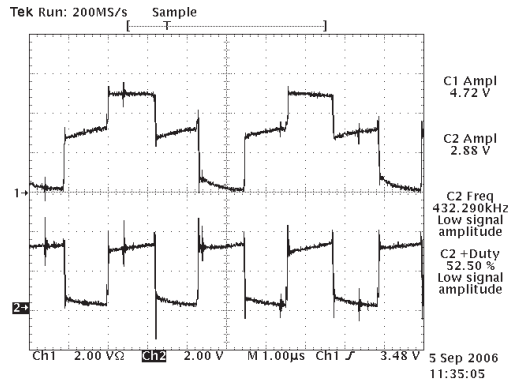
SP3225E/SP3227E Charge Pump Out of Shutdown

All Charge Pump waveforms use charge pump capacitor values C1-C4 = 0.1μF

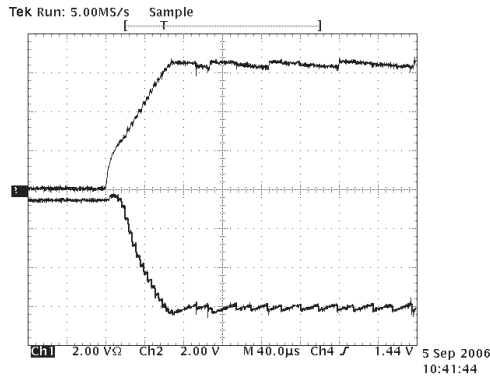
TYPICAL PERFORMANCE CHARACTERISTICS



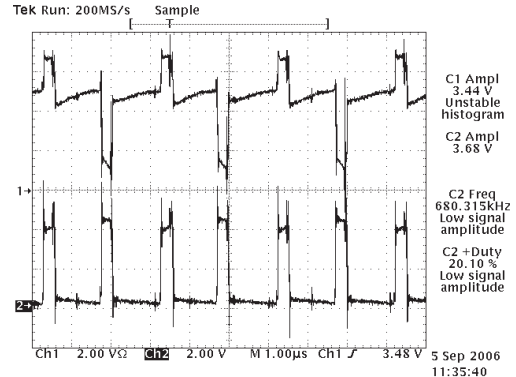
SP3225E/SP3227E Charge Pump
Into Shutdown



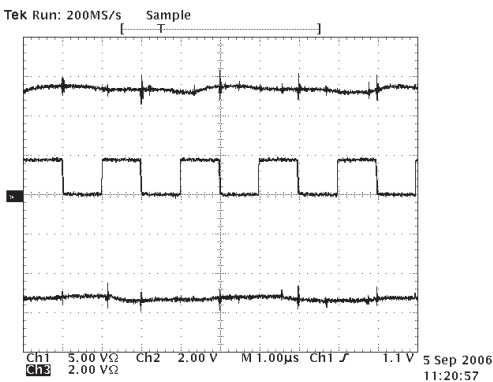
SP3225E/SP3227E Charge Pump
Waveforms, Vcc=3.3V, All Chan-
nel Switching



SP3225E/SP3227E Charge Pump
Power On Time, Vcc=3.3V



SP3225E/SP3227E Charge Pump
Waveforms, Vcc=5V, All Channel
Switching



SP3225E/SP3227E Charge Pump
Waveforms for 1Mbps Clock Rate

All Charge Pump waveforms use charge pump capacitor values C1-C4 = 0.1μF

CHARACTERIZATION CIRCUITS AND WAVEFORMS

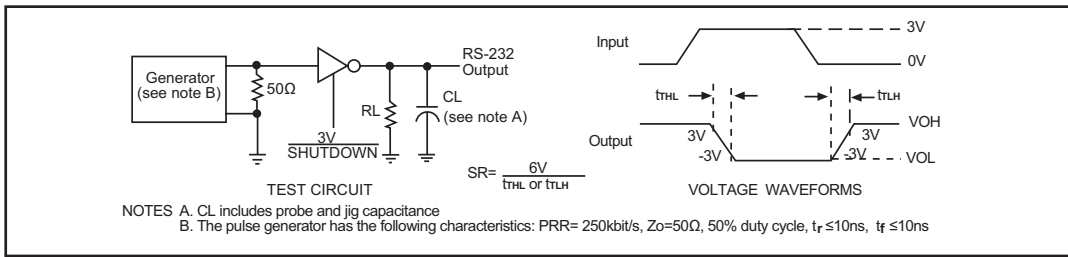


Figure 1. Driver Slew Rate

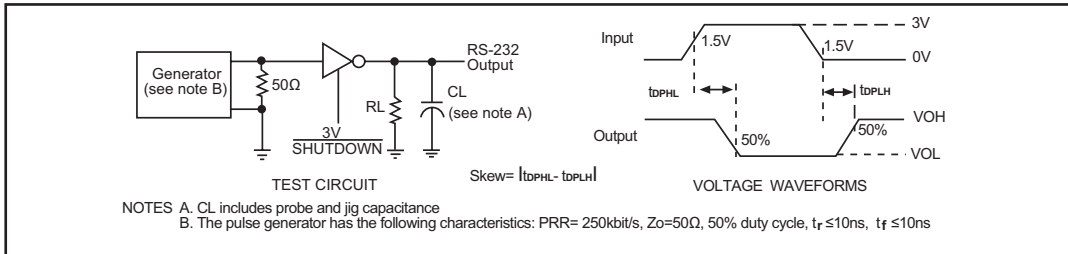


Figure 2. Driver Propagation and Skew

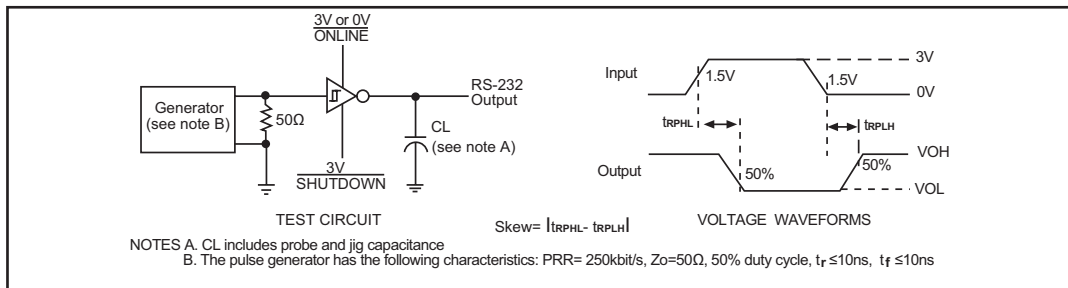


Figure 3. Receiver Propagation Delay and Skew

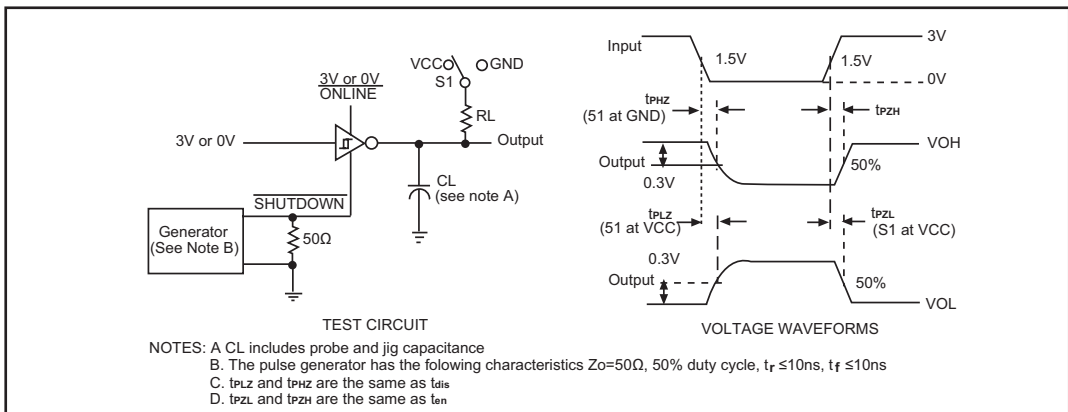


Figure 4. Receiver Enable and Disable Times

Description

The SP3224E and SP3225E are 2-driver/2-receiver devices. The SP3226E and SP3227E are 1-driver/1-receiver devices. All are ideal for serial ports in embedded, consumer, portable, or handheld applications. The transceivers meet the EIA/TIA-232 and ITU-T V.28/V.24 communication protocols for reliable serial communication. The devices feature Exar's proprietary and patented (U.S. 5,306,954) on-board charge pump circuitry that generates $\pm 5.5\text{V}$ RS-232 voltage levels from a single +3.0V to +5.5V power supply.

The SP3224E-SP3227E are ideal choices for power sensitive designs. With the Auto On-line[®] Plus enabled, the SP3224E-SP3227E reduce supply current to $1\mu\text{A}$ whenever the transceivers are in idle. In shutdown, the internal charge pump and the drivers will shut down. This feature allows design engineers to address power saving concerns without major design changes.

Theory Of Operation

The SP3224E-SP3227E are made up of four basic circuit blocks: 1. Drivers, 2. Receivers, 3. the Exar proprietary charge pump, and 4. Auto On-line[®] Plus circuitry.

Drivers

The drivers are inverting level transmitters that convert TTL or CMOS logic levels to 5.0V EIA/TIA-232 levels with an inverted sense relative to the input logic levels. Typically, the RS-232 output voltage swing is +5.4V with no load and +5V minimum fully loaded. The driver outputs are protected against infinite short-circuits to ground without degradation in reliability. These drivers comply with the EIA-TIA-232-F and all previous RS-232 versions. Unused driver inputs should be connected to GND or VCC.

The drivers can guarantee output data

rates fully loaded with $3\text{K}\Omega$ in parallel with 1000pF (SP3224E/SP3226E), or $3\text{K}\Omega$ in parallel with 250pF (SP3225E/SP3227E) ensuring compatibility with PC-to-PC communication software. The slew rate of the driver output on the SP3224E/SP3226E is internally limited to a maximum of $30\text{V}/\mu\text{s}$ in order to meet the EIA standards (EIA RS-232D 2.1.7, Paragraph 5). The Slew Rate of SP3225E/SP3227E is not limited to enable higher speed data transfers. The transition of the loaded output from HIGH to LOW also meets the monotonic signal transition requirements of the standard.

Receivers

The receivers convert EIA/TIA-232 signal levels to TTL or CMOS logic output levels. Receivers remain active during device shutdown. Since receiver input is usually from a transmission line where long cable lengths and system interference can degrade the signal, the inputs have a typical hysteresis margin of 500mV. This ensures that the receiver is virtually immune to noisy transmission lines. Should an input be left unconnected, an internal $5\text{K}\Omega$ pulldown resistor to ground will commit the output of the receiver to a HIGH state.

Charge Pump

The charge pump is a Exar-patented design (US Patent #5,306,954) and uses a unique approach compared to older less-efficient designs. The charge pump still requires four external capacitors, but uses a four phase voltage shifting technique to attain symmetrical 5.5V power supplies. The internal power supply consists of a regulated dual charge pump that provides output voltages 5.5V regardless of the input voltage (V_{CC}) over the +3.0V to +5.5V range. This is important to maintain compliant RS-232 levels regardless of power supply fluctuations.

The charge pump operates in a discontinuous mode using an internal oscillator. If the output voltages are less than a magnitude

of 5.5V, the charge pump is enabled. If the output voltages exceed a magnitude of 5.5V, the charge pump is disabled. This oscillator controls the four phases of the voltage shifting. A description of each phase follows.

Highly Efficient Charge Pump

The charge pump is used to generate positive and negative signal voltages for the RS-232 drivers. This enables fully compliant RS-232 and V.28 signals from a single 3.0 or 5.5V power supply.

The charge pumps use four external capacitors to hold and transfer electrical charge. The Exar patented design (US Patent #5,306,954) uses a unique approach compared to older less efficient designs. The pumps use a four-phase voltage shifting technique to attain symmetrical V^+ and V^- power supplies. An intelligent control oscillator regulates the operation of the charge pump to maintain the proper voltages at maximum efficiency.

Phase 1

V_{SS} charge store and double: The positive terminals of capacitors C1 and C2 are charged from V_{CC} with their negative terminals initially connected to ground. C1+ is then connected to ground and the stored charge from C1- is superimposed onto C2-. Since C2+ is still connected to V_{CC} the voltage potential across capacitor C2 is now $2 \times V_{CC}$.

Phase 2

V_{SS} transfer and invert: Phase two connects the negative terminal of C2 to the V_{SS} storage capacitor and the positive terminal of C2 to ground. This transfers the doubled and inverted (V^-) voltage onto C4. Meanwhile, capacitor C1 charged from V_{CC} to prepare it for its next phase.

Phase 3

V_{DD} charge store and double: Phase three

is identical to the first phase. The positive terminals of capacitors C1 and C2 are charged from V_{CC} with their negative terminals initially connected to ground. C1+ is then connected to ground and the stored charge from C1- is superimposed onto C2-. Since C2+ is still connected to V_{CC} the voltage potential across capacitor C2 is now $2 \times V_{CC}$.

Phase 4

V_{DD} transfer: The fourth phase connects the negative terminal of C2 to ground and the positive terminal of C2 to the V_{DD} storage capacitor. This transfers the doubled (V^+) voltage onto C3. Meanwhile, capacitor C1 charged from V_{CC} to prepare it for its next phase.

The Exar charge pump generates V^+ and V^- independently from V_{CC} . Hence in a no-load condition V^+ and V^- will be symmetrical. Older charge pump approaches generate V^+ and then use part of that stored charge to generate V^- . Because of inherent losses the magnitude of V^- will be smaller than V^+ on these older designs.

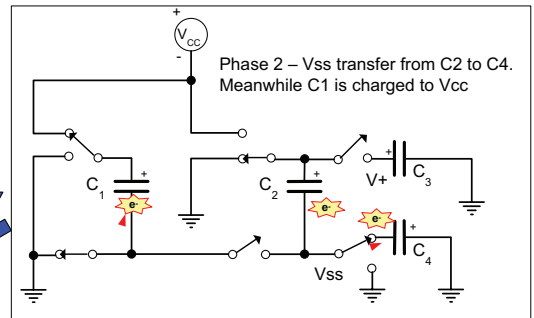
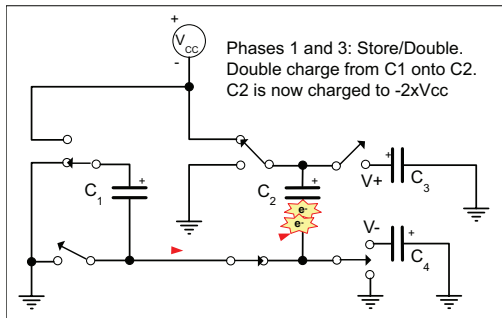
Under lightly loaded conditions the intelligent pump oscillator maximizes efficiency by running only as needed to maintain V^+ and V^- . Since interface transceivers often spend much of their time at idle this power-efficient innovation can greatly reduce total power consumption. This improvement is made possible by the independent phase sequence of the Exar charge pump design.

The clock rate for the charge pump typically operates at greater than 70kHz allowing the pump to run efficiently with small 0.1 μ F capacitors. Efficient operation depends on rapidly charging and discharging C1 and C2, therefore capacitors should be mounted close to the IC and have low ESR (equivalent series resistance). Inexpensive surface mount ceramic capacitors (such as

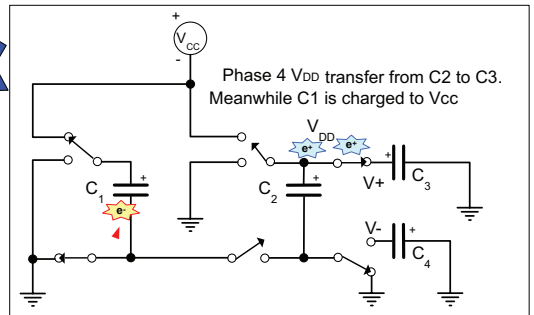
are widely used for power-supply decoupling) are ideal for use on the charge pump. The charge pumps are designed to be able to function properly with a wide range of capacitor styles and values. If polarized capacitors are used the positive and negative terminals should be connected as shown on the Typical Operating Circuit.

Capacitance values may be increased if operating at higher V_{CC} or to provide greater stability as the capacitors age.

The SP3224E-SP3227E devices have the advanced Auto On-Line[®] Plus feature RS-232 signals use both positive and negative voltages of greater than $\pm 5V$ magnitude. Receivers have nominal $5k\Omega$ impedance to ground. Even when idle, drivers will maintain output signal voltage creating a continuous current flow. In low power, battery operated devices this constant current drain can decrease battery life significantly.



Patented 5,306,954



Charge Pump Phases

Minimum Recommended Charge Pump Capacitor Values	
Input Voltage V_{CC}	Charge Pump Capacitor Value for SP32XX
3.0V to 3.6V	C1-C4=0.1 μ F
4.5V to 5.5V	C1=0.047 μ F, C2-C4=0.33 μ F
3.0V to 5.5V	C1-C4=0.22 μ F

Charge Pump Capacitor Values

that saves power by turning off the charge pumps and driver outputs when the transceiver inputs are idle for more than 30 seconds. Auto On-line[®] Plus is equivalent to Maxim's "Auto Shutdown Plus" feature. It differs from our existing Auto On-line[®] by relying on signal transitions rather than voltage levels to trigger shutdown and wakeup.

Auto On-Line[®] Plus automatically puts the device into a standby mode where it draws only 1 μ A typical. When the device detects activity on either the receiver or driver inputs it will automatically awake and activate to allow serial communication. Both the wakeup and shutdown happen automati-

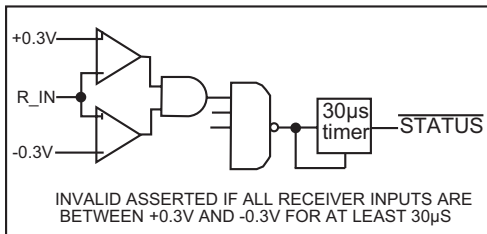
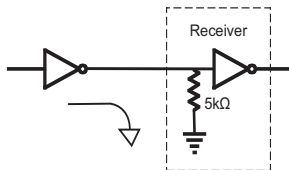


Figure 3a. STATUS Functional Diagram STATUS low

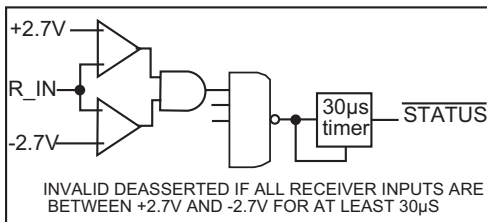


Figure 3b. STATUS Functional Diagram, STATUS high.

cally, without any user intervention, special drivers, or software modifications.

Wakeup and shutdown can be externally controlled by the ONLINE and SHUTDOWN pins. When ONLINE is driven to logic LOW, the Auto On-line[®] Plus function is active. Driving SHUTDOWN to

logic LOW forces the device into shutdown state regardless of input activity or the status of the ONLINE pin.

The STATUS output determines whether a valid RS-232 signal voltage is present on the inputs. The STATUS pin goes to a logic LOW when the receiver input signal levels collapse near reference ground. This may occur when the RS-232 cable is disconnected or the RS-232 drivers of the connected peripheral are turned off.

STATUS may be used to indicate DTR or a Ring Indicator signal or to determine whether a live RS232 driver or cable is connected. By connecting the STATUS output to ONLINE input, the SP3224E-SP3227E will shut down when no valid signal level and no input transitions are detected, and wake up on a valid signal level or signal edge. If it detects no signal transitions with the past 30

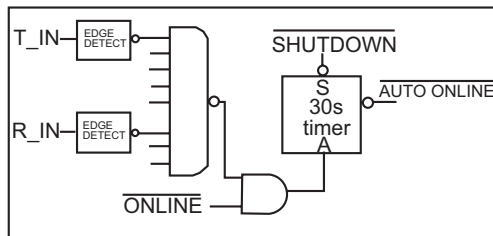


Figure 3c. Auto On-line Plus Logic

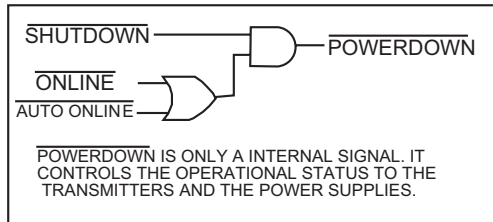


Figure 3d. Powerdown Logic

seconds, the device will go into low power mode. By connecting the STATUS output to both the ONLINE input and SHUTDOWN input pins, the device enters into shutdown when not receiving a valid RS-232 signal voltage input.

When the SP3224E-SP3227E devices are

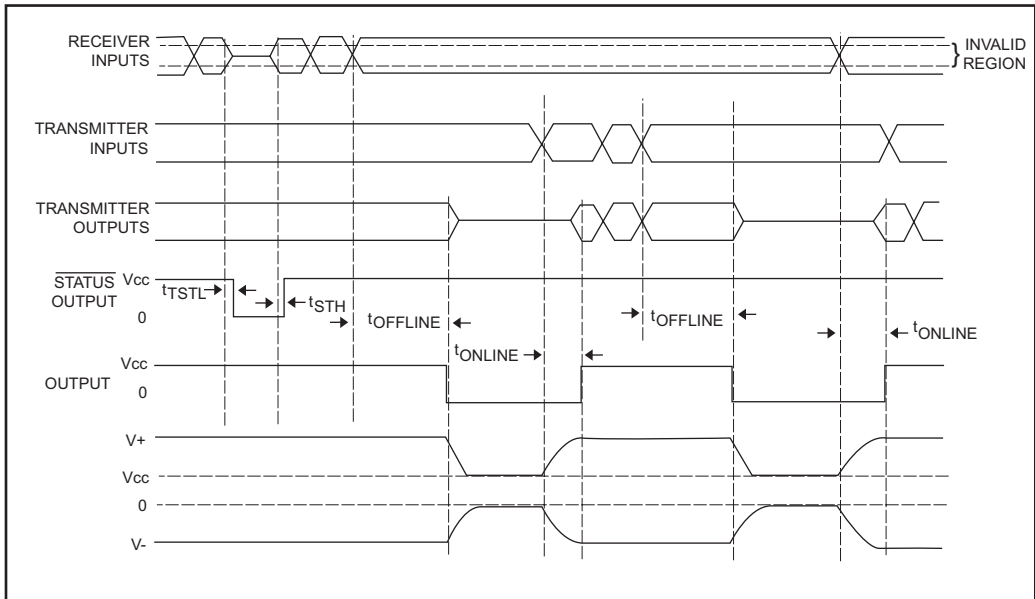
shut down, the charge pumps are turned off. V+ charge pump output decays to VCC, the V- output decays to GND. The decay time will depend on the size of capacitors used for the charge pump. Once in shutdown, the time required to exit the shutdown state and have valid V+ and V- levels is typically 50µs. When the SP3224E-SP3227E drivers and internal charge pump are disabled, the supply current is reduced to 1µA.

Auto On-Line (existing)	Device enters low-power mode if receiver inputs see less than valid +/- 3V.
	STATUS (or INVALID) signal output indicates if valid signal voltage is at receivers.
Auto On-Line Plus (new)	Device enters low-power mode if driver inputs or receiver inputs see no transitions for 30 seconds. Return to full power mode upon any transition on any driver input or receiver input
	Shutdown occurs even if data cable is connected to an active driver, as long as all inputs remain unchanged
	STATUS (or INVALID) signal functions as before. Indicates if valid signal voltage is present. But has no effect on shutdown
	For SP3224E the $\overline{\text{EN}}$ input is replaced with a READY output. READY drives high when charge pump achieves greater than -4V Vss (V-). Indicates "ready to transmit."

Comparison of Auto On-line[®] Features

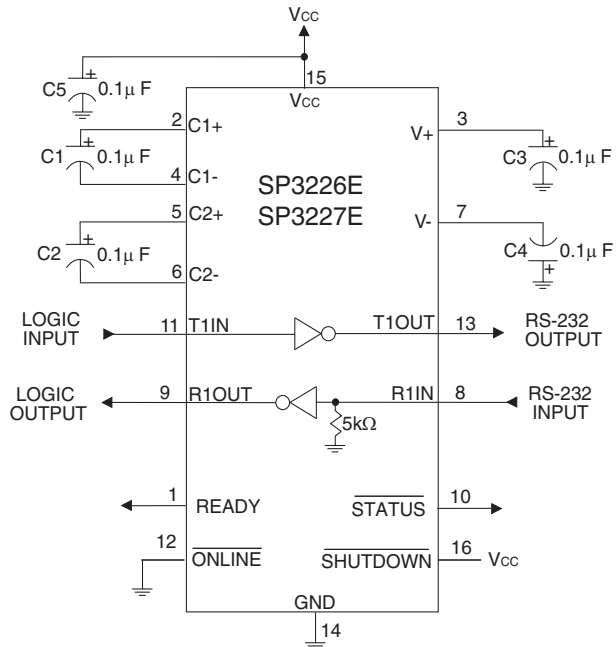
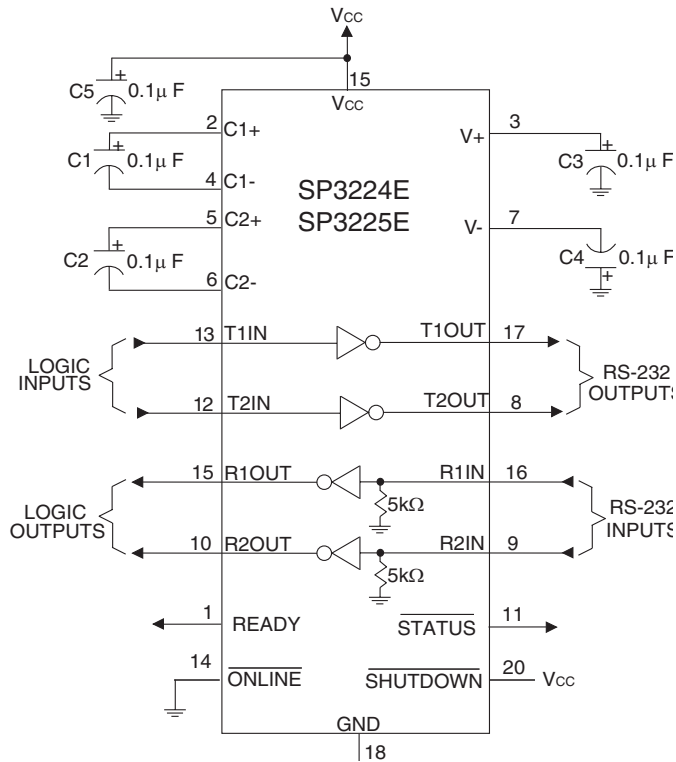
Operating Mode	$\overline{\text{ONLINE}}$	SHDN	$ \text{RIN} > \pm 2.7\text{V}$	Idle Inputs (RXIN & TXIN)	TXOUT	RXOUT
Forced Shutdown	X	0	X	X	Hi-Z	Active
Forced On-Line	1	1	X	X	Active	Active
Auto On-Line Plus (Wake when active)	0	1	X	Active	Active	Active
Auto On-Line Plus (Off-Line when idle)	0	1	X	Idle > 30s	Hi-Z	Active
Auto On-Line Plus (Wake on cable)	STATUS	1	Yes	X	Active	Active
Auto On-Line Plus (Wake when active)	STATUS	1	No	Active	Active	Active
Auto On-Line Plus (Off-Line when idle)	STATUS	1	No	Idle > 30s	Hi-Z	Active
Auto On-Line (Wake on cable)	STATUS	STATUS	Yes	X	Active	Active
Auto On-Line (Auto Shutoff)	STATUS	STATUS	No	X	Hi-Z	Active

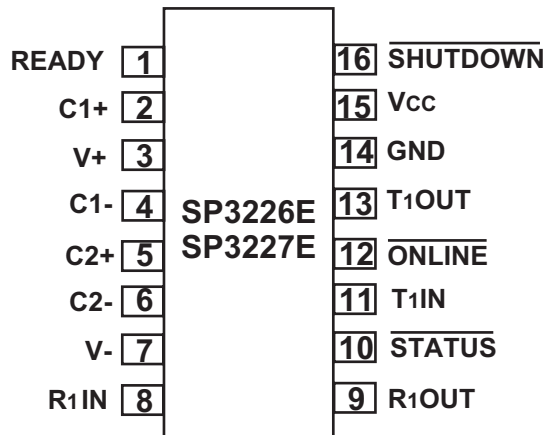
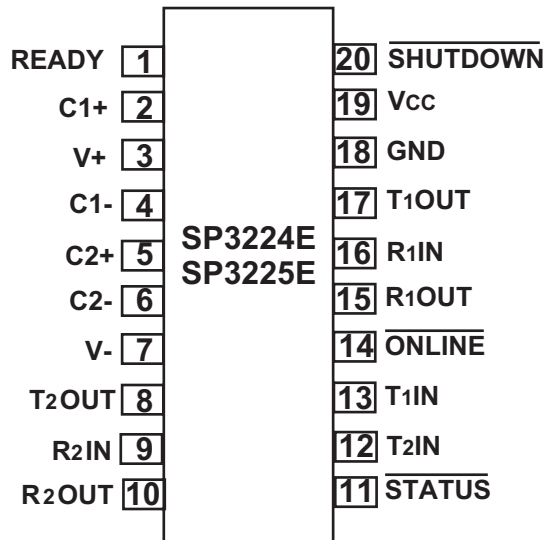
Auto On-line[®] Plus Truth Table



Auto On-Line® Plus Timing Diagram

 t_{STL} (=30 μ s typ.) t_{STH} (=0.4 μ s typ.) $t_{OFFLINE}$ (=30s typ.) t_{ONLINE} (=100 μ s typ.)





REVISION HISTORY			
REV.	DISCRIPTION	DATE	APP'D
A	DRAWING ORIGINATOR	04/19/06	JL
B	ADD LAND PATTERN RECOMMENDATION	10/27/06	JL
C	CHANGE DRAWING LOGO AND COMPANY NAME	11/21/07	JL

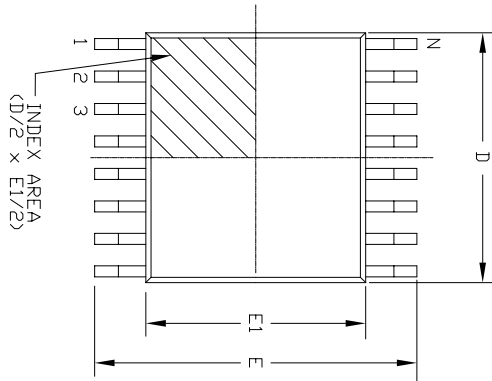
20 Pin TSSOP JEDEC MO-153 Variation AC					
SYMBOLS	DIMENSIONS IN MM (Control Unit)		DIMENSIONS IN INCH (Reference Unit)		
	MIN	NOM	MAX	MIN	NOM
A	—	—	1.20	—	0.047
A1	0.05	—	0.15	0.002	0.006
A2	0.80	1.00	1.05	0.031	0.039
b	0.19	—	0.30	0.007	0.012
c	0.09	—	0.20	0.004	0.008
E	6.40 BSC		0.252 BSC		
E1	4.30	4.40	4.50	0.169	0.173
e	0.65 BSC		0.026 BSC		
L	0.45	0.60	0.75	0.018	0.024
L1	1.00 REF		0.039 REF		
L2	0.25 BSC		0.010 BSC		
R	0.09	—	—	0.035	—
R1	0.09	—	—	0.035	—
θ	12° REF		12° REF		
θ1	0°	—	8°	0°	8°
D	6.40	6.50	6.60	0.252	0.256
N	20		20		

	EXAR CORPORATION	
	20 PIN TSSOP PACKAGE OUTLINE	

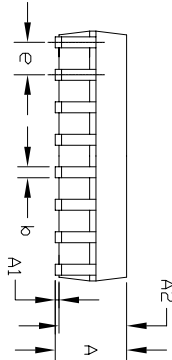
Packaging Approval:	Drawing No:	20-PIN TSSOP
By: JL Date: 11/21/07	Revision: C	Sheet: 1 OF 1

REVISION HISTORY			
REV.	DESCRIPTION	DATE	APPROD
A	DRAWING ORIGINATOR	04/24/06	JL
B	CHANGE DRAWING LOGO AND COMPANY NAME	11/21/07	JL

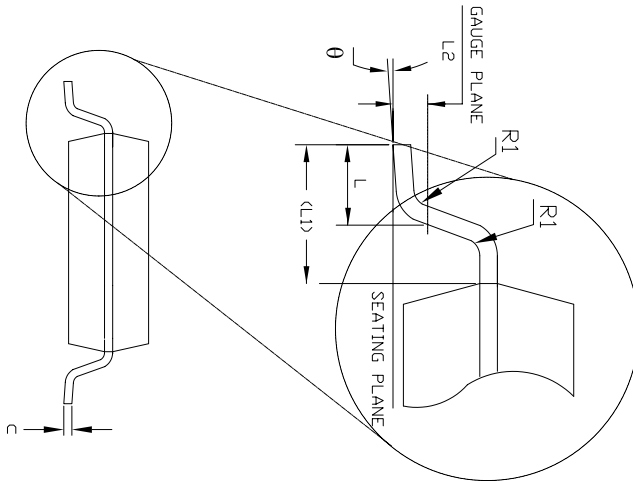
Top View



Side View



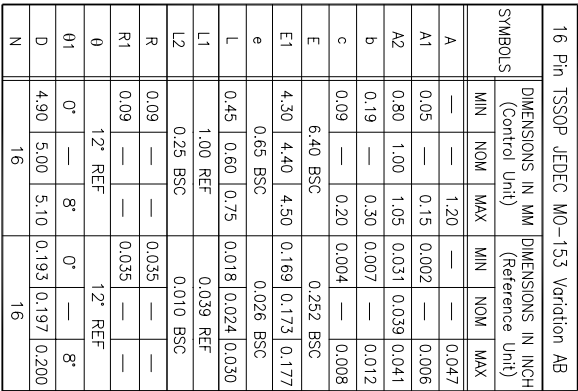
Front View



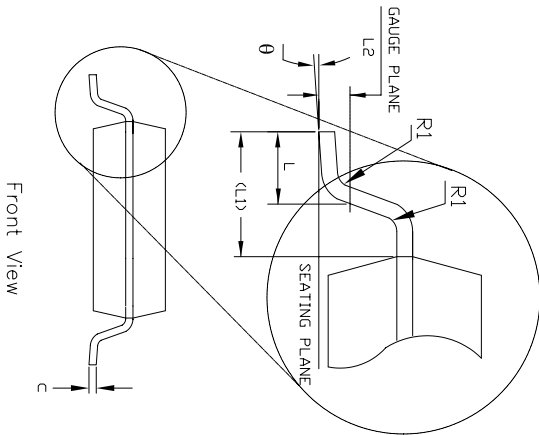
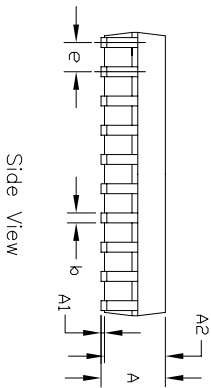
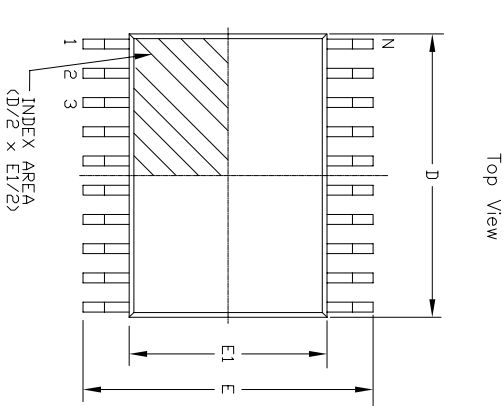
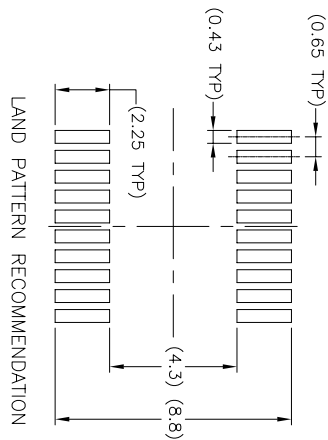
16 Pin SSOP JEDEC MO-150 Variation AC									
SYMBOLS	DIMENSIONS IN MM (Control Unit)				DIMENSIONS IN INCH (Reference Unit)				
	MIN	NOM	MAX		MIN	NOM	MAX		
A	—	—	2.00	—	—	—	0.079		
A1	0.05	—	—	0.002	—	—	—		
A2	1.65	1.75	1.85	0.065	0.069	0.073			
b	0.22	—	0.38	0.009	—	0.015			
c	0.09	—	0.25	0.004	—	0.010			
E	7.40	7.80	8.20	0.291	0.307	0.323			
E1	5.00	5.30	5.60	0.197	0.209	0.220			
e	0.65 BSC				0.026 BSC				
L	0.55	0.75	0.95	0.022	0.030	0.037			
L1	1.25 REF				0.049 REF				
L2	0.25 BSC				0.010 BSC				
R1	0.09	—	—	0.004	—	—			
theta	0°	4°	8°	0°	4°	8°			
D	5.90	6.20	6.50	0.232	0.244	0.256			
N	16				16				

				EXAR CORPORATION			
Packaging Approval:		Drawing No:		16-PIN SSOP		16 PIN SSOP PACKAGE OUTLINE	
By: JL	Date: 11/21/07	Revision: B	Sheet: 1 OF 1				

		EXAR CORPORATION	
Packaging Approval:		16 PIN TSSOP PACKAGE OUTLINE	
By: JL	Date: 11/21/07	Drawing No: 16-PIN TSSOP	
Revision: C	Sheet: 1 OF 1		



REVISION HISTORY			
REL.	DISCRIPTION	DATE	APP'D
A	DRAWING ORIGINATOR	04/24/06	JL
B	ADD LAND PATTERN RECOMMENDATION	07/25/07	JL
C	CHANGE DRAWING LOGO AND COMPANY NAME	11/21/07	JL



20 Pin SSOP JEDEC MO-150 Variation AE									
DIMENSIONS IN MM (Control Unit)				DIMENSIONS IN INCH (Reference Unit)					
SYMBOLS	MIN	NOM	MAX	MIN	NOM	MAX	MIN	NOM	MAX
A	—	—	2.00	—	—	0.079	—	—	—
A1	0.05	—	—	0.002	—	—	—	—	—
A2	1.65	1.75	1.85	0.065	0.069	0.073	—	—	—
b	0.22	—	0.38	0.009	—	0.015	—	—	—
c	0.09	—	0.25	0.004	—	0.010	—	—	—
E	7.40	7.80	8.20	0.291	0.307	0.323	—	—	—
E1	5.00	5.30	5.60	0.197	0.209	0.220	—	—	—
e	0.65	BSC	—	0.026	BSC	—	—	—	—
L	0.55	0.75	0.95	0.022	0.030	0.037	—	—	—
L1	1.25	REF	—	0.049	REF	—	—	—	—
L2	0.25	BSC	—	0.010	BSC	—	—	—	—
R1	0.09	—	—	0.004	—	—	—	—	—
theta	0°	4°	8°	0°	4°	8°	—	—	—
D	6.90	7.20	7.50	0.272	0.283	0.295	—	—	—
N	20	20	20	20	20	20	—	—	—

		EXAR CORPORATION	
Packaging Approval:	20 PIN SSOP PACKAGE OUTLINE	Drawing No:	20-PIN SSOP
By: JL	Date: 11/21/07	Revision: C	Sheet: 1 OF 1

Part number	Temperature range	Package Type
SP3224ECA-L	From 0°C to +70°C	Lead Free 20 pin SSOP
SP3224ECY-L	From 0°C to +70°C	Lead Free 20 pin TSSOP
SP3224EEA-L	From -40°C to +85°C	Lead Free 20 pin SSOP
SP3224EEY-L	From -40°C to +85°C	Lead Free 20 pin TSSOP
SP3225ECA-L	From 0°C to +70°C	Lead Free 20 pin SSOP
SP3225ECY-L	From 0°C to +70°C	Lead Free 20 pin TSSOP
SP3225EEA-L	From -40°C to +85°C	Lead Free 20 pin SSOP
SP3225EEY-L	From -40°C to +85°C	Lead Free 20 pin TSSOP
SP3226ECA-L	From 0°C to +70°C	Lead Free 16 pin SSOP
SP3226ECY-L	From 0°C to +70°C	Lead Free 16 PIN SSOP
SP3226EEA-L	From -40°C to +85°C	Lead Free 16 pin SSOP
SP3226EEY-L	From -40°C to +85°C	Lead Free 16 PIN TSSOP
SP3227ECA-L	From 0°C to +70°C	Lead Free 16 PIN SSOP
SP3227ECY-L	From 0°C to +70°C	Lead Free 16 PIN TSSOP
SP3227EEA-L	From -40°C to +85°C	Lead Free 16 PIN SSOP
SP3227EEY-L	From -40°C to +85°C	Lead Free 16 PIN TSSOP

Available in Tape on Reel

DATE	REVISION	DESCRIPTION
11-20-06	P	Legacy Sipex Datasheet
12-14-09	1.0.0	Update to Exar Format. Change revision to 1.0.0. Change Supply Current Active over full Vcc range maximum from 2.0mA to 3.0mA. Change Supply Current Active at Vcc = 3.3V maximum from 1.0mA to 2.0mA. Change RX input voltage ABS Maximum Rating from +/-18V to +/-16V.
08-17-11	1.0.1	Correct type error on front page Features list.

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Datasheet August 2011

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